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SEMICONDUCTOR®

FDMS7658AS N-Channel PowerTrench[®] SyncFETTM 30 V, 49 A, 1.9 m Ω

Features

- Max r_{DS(on)} = 1.9 mΩ at V_{GS} = 10 V, I_D = 28 A
- Max $r_{DS(on)}$ = 2.2 m Ω at V_{GS} = 7 V, I_D = 26 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- SyncFET Schottky Body Diode
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

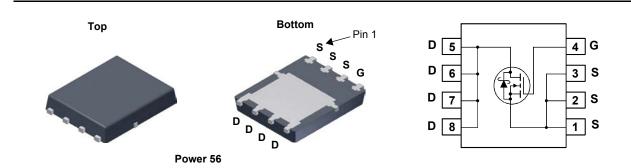


General Description

The FDMS7658AS has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest $r_{DS(on)}$ while maintaining excellent switching performance. This device has the added benefit of an efficient monolithic Schottky body diode.

Applications

- Synchronous Rectifier for DC/DC Converters
- Notebook Vcore/ GPU low side switch
- Networking Point of Load low side switch
- Telecom secondary side rectification



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units
V _{DS}	Drain to Source Voltage			30	V
V _{GS}	Gate to Source Voltage		(Note 4)	±20	V
ID	Drain Current -Continuous (Package limited)	T _C = 25 °C		49	
	-Continuous (Silicon limited)	T _C = 25 °C		177	^
	-Continuous	T _A = 25 °C	(Note 1a)	29	Α
	-Pulsed			150	
dv/dt	MOSFET dv/dt			1.5	V/ns
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	162	mJ
P _D	Power Dissipation	T _C = 25 °C		89	w
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	vv
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C

Thermal Characteristics

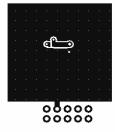
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.4	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 50	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7658AS	FDMS7658AS	Power 56	13 "	12 mm	3000 units

September 2009

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0 V	30			V	
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 10 mA, referenced to 25 °C		23		mV/°C	
DSS	Zero Gate Voltage Drain Current	V _{DS} = 24 V, V _{GS} = 0 V			500	μA	
GSS	Gate to Source Leakage Current, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA	
On Chara	cteristics (Note 2)						
V _{GS(th)}	Gate to Source Threshold Voltage	V_{GS} = V_{DS} , I_D = 1 mA	1.2	1.7	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 10 mA, referenced to 25 °C		-5		mV/°C	
		V _{GS} = 10 V, I _D = 28 A		1.5	1.9	mΩ	
	Statia Drain to Source On Desistance	V _{GS} = 7 V, I _D = 26 A		1.7	2.2		
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 4.5 V, I _D = 23 A		1.9	2.4		
		V_{GS} = 10 V, I _D = 28 A, T _J = 125 °C		2.0	2.6		
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 28 A		181		S	
Dynamic	Characteristics						
C _{iss}	Input Capacitance			5525	7350	pF	
C _{oss}	Output Capacitance	− V _{DS} = 15 V, V _{GS} = 0 V, _ f = 1 MHz		2020	2685	pF	
C _{rss}	Reverse Transfer Capacitance			150	230	pF	
R _g	Gate Resistance			0.4	0.9	Ω	
Switching	g Characteristics						
d(on)	Turn-On Delay Time			20	36	ns	
r	Rise Time	V _{DD} = 15 V, I _D = 28 A,		8	17	ns	
d(off)	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		43	70	ns	
f	Fall Time	1		5	10	ns	
Q _g	Total Gate Charge	V _{GS} = 0 V to 10 V		78	109	nC	
Q _g	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 15 V,$		35	49	nC	
Q _{gs}	Gate to Source Gate Charge	I _D = 28 A		16.4		nC	
Q _{gd}	Gate to Drain "Miller" Charge			6.6		nC	
Drain-Sou	urce Diode Characteristics						
		$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.38	0.9	.,	
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 28 A$ (Note 2)		0.74	1.3	V	
rr	Reverse Recovery Time	- I _F = 28 A, di/dt = 300 A/μs		46	75	ns	
Q _{rr}	Reverse Recovery Charge	$-1F - 20 A, u/ul = 300 A/\mu S$		73	117	nC	



a. 50 °C/W when mounted on a 1 in² pad of 2 oz copper.

b. 125 °C/W when mounted on a minimum pad of 2 oz copper.



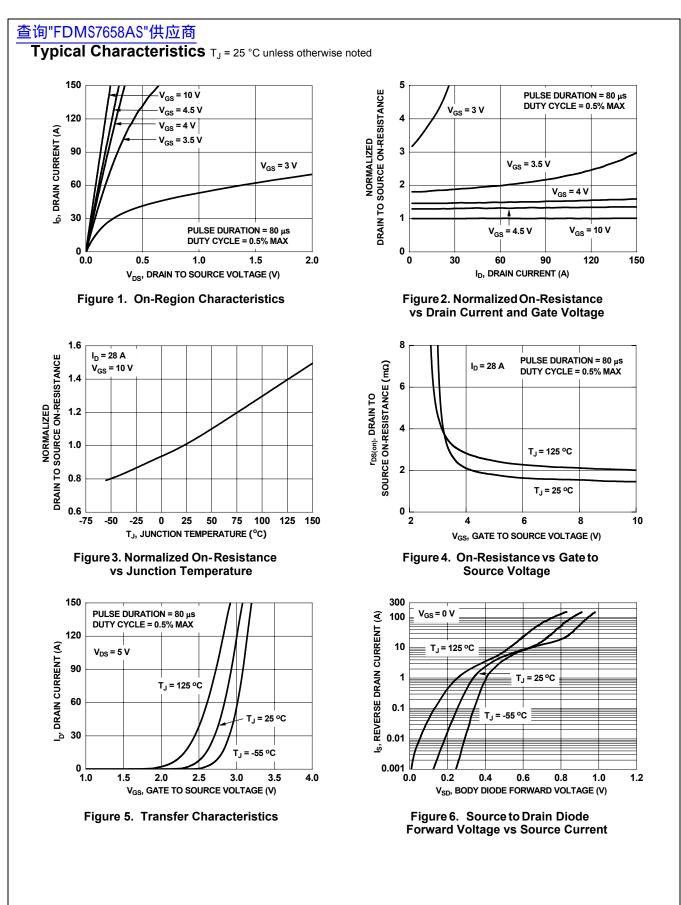
2. Pulse Test: Pulse Width < 300 $\mu\text{s},$ Duty cycle < 2.0%.

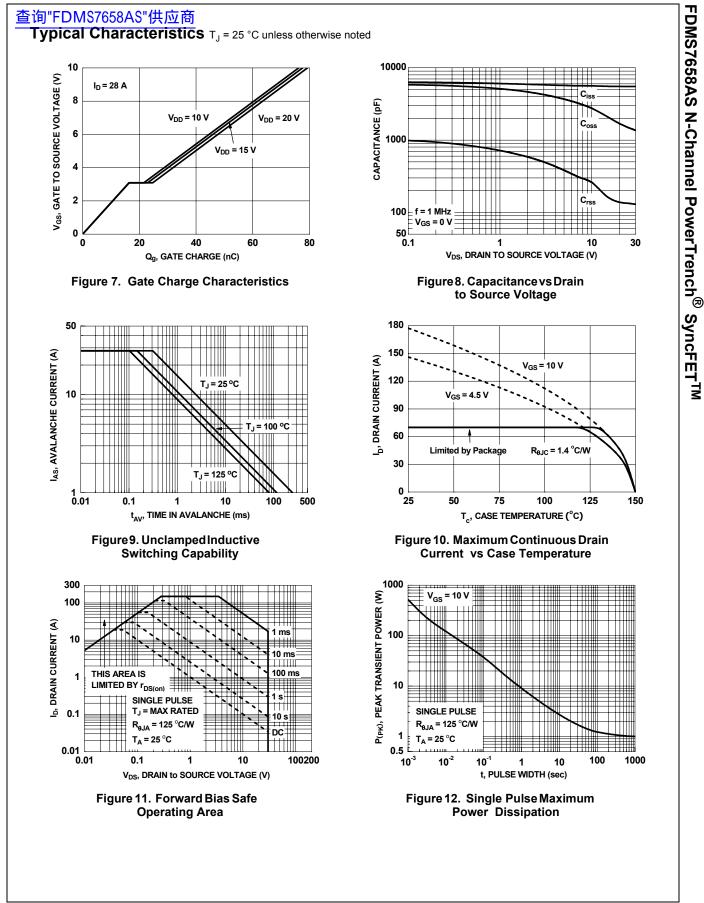
3. E_{AS} of 162 mJ is based on starting T_J = 25 °C, L = 1 mH, I_{AS} = 18 A, V_{DD} = 27 V, V_{GS} = 10 V. 100% test at L = 0.3 mH, I_{AS} = 28 A.

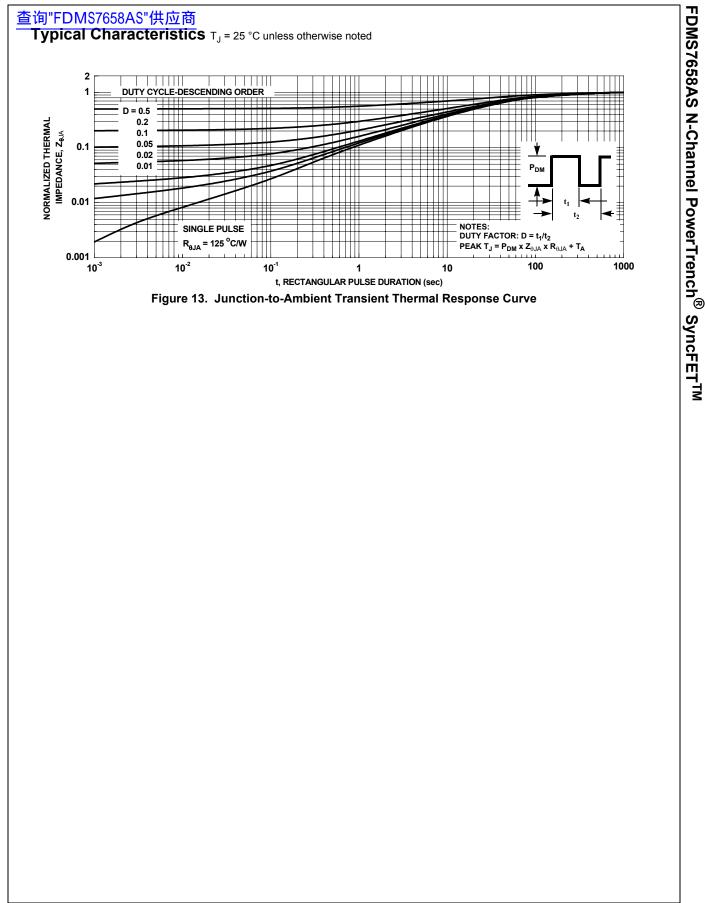
4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

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查询"FDMS7658AS"供应商 Typical Characteristics (continued)

SyncFET Schottky body diode Characteristics

Fairchild's SyncFET process embeds a Schottky diode in parallel with PowerTrench MoSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverses recovery characteristic of the FDMS7658AS.

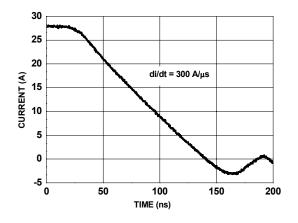


Figure 14. FDMS7658AS SyncFET body diode reverse recovery characteristic

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

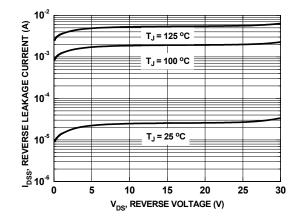
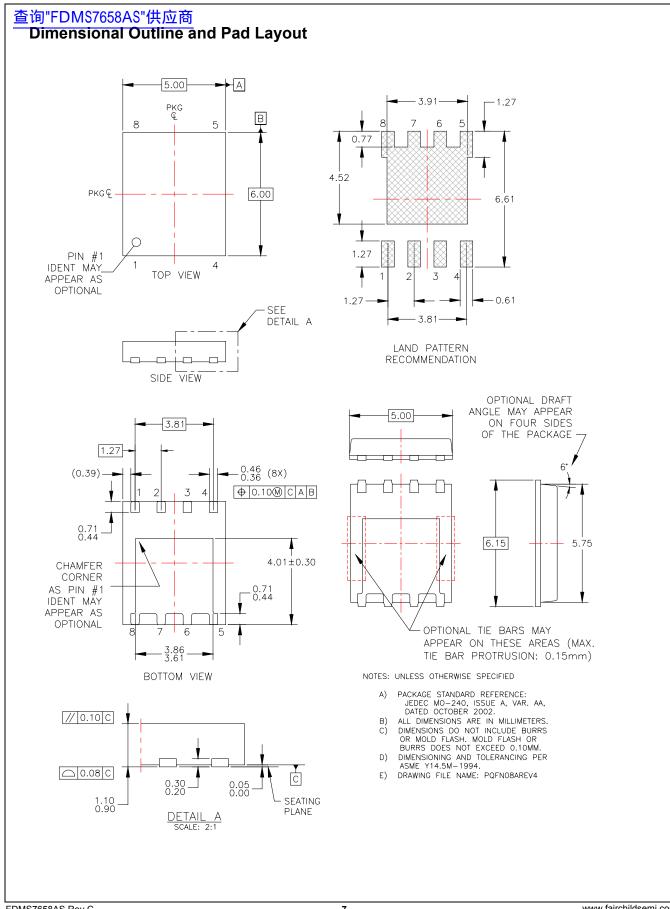


Figure 15. SyncFET body diode reverses leakage versus drain-source voltage



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